

 BRIEF DESCRIPTION OF DRAWINGS

FIGS. 1A-1K are views for explaining fabricating steps according to a first embodiment of the invention;

FIGS. 2A-2B are view for explaining a case where a semiconductor IC board fabricated according to the first embodiment of the invention is connected to an external printed board;

FIGS. 3A-3B are views for explaining a case where the semiconductor IC board fabricated according to the first embodiment of the invention is filled with an insulating material;

FIG. 4 is a view for explaining a case where a guide mark is attached to the semiconductor IC board fabricated according to the first embodiment of the invention;

FIGS. 5A-5B are views for explaining side views in FIG. 8;

FIGS. 6A-6C are views for explaining a case where heights of metal posts which are fabricated according to the first embodiment of the invention are varied;

FIGS. 7A-7K and 8A-8D are views for explaining fabricating steps according to a second embodiment of the invention;

FIGS. 9A-9I are views for explaining fabricating steps according to a third embodiment of the invention;

FIGS. 10 and 11 are views for explaining fabricating steps according to a fourth embodiment of the invention;

Cont. A

Ken Ogura

OKI.244

FIGS. 12A-12C, 13A-13C, 14A-14B and 15A-15C are views for explaining fabricating steps according to a fifth embodiment of the invention;

FIGS. 16A-16E and 17A-17B are views for explaining fabricating steps according to a sixth embodiment of the invention;

FIGS. 18A-18H are views for explaining fabricating steps according to a seventh embodiment of the invention;

FIGS. 19A-19D are views for explaining fabricating steps according to an eighth embodiment of the invention;

FIGS. 20A-20D are views for explaining fabricating steps according to a ninth embodiment of the invention;

FIGS. 21A-21C and 22A-22D are views for explaining fabricating steps according to a tenth embodiment of the invention;

FIGS. 23A-23D are views for explaining fabricating steps according to an eleventh embodiment of the invention;

FIGS. 24A-24G are views for explaining fabricating steps according to an eleventh embodiment of the invention;

FIGS. 25A-25C are views for explaining the construction according to a thirteenth embodiment of the invention;